

Features :

- Isolated mounting base3000V~
- Pressure contact technology with Increased power cycling capability
- Space and weight saving

Typical Applications

- Various rectifiers
- DC supply for PWM inverter

V_{RSM}	V_{RRM}	品名
2100V	2000V	Mx250D200
2300V	2200V	Mx250D220
2600V	2500V	Mx250D250

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T_j (°C)	VALUE			UNIT
				Min.	Typ.	Max.	
$I_{F(AV)}$	Mean forward current	180° half sine wave 50Hz Single side cooled, $T_c=100^\circ\text{C}$	150			250	A
$I_{F(RMS)}$	RMS forward current		150			393	A
I_{RRM}	Repetitive peak current	at V_{RRM}	150			20	mA
I_{FSM}	Surge forward current	10ms half sine wave $V_R=0.6V_{RRM}$	150			9.0	kA
I^2t	I^2t for fusing coordination					405	$\text{A}^2\text{s} \times 10^3$
V_{FO}	Threshold voltage		150			0.85	V
r_F	Forward slope resistance					0.70	$\text{m}\Omega$
V_{FM}	Peak forward voltage	$I_{FM}=750\text{A}$	25			1.43	V
$R_{th(j-c)}$	Thermal resistance Junction to case	D.C. Single side cooled per chip				0.13	$^\circ\text{C}/\text{W}$
$R_{th(c-h)}$	Thermal resistance case to heatsink	D.C. Single side cooled per chip				0.04	$^\circ\text{C}/\text{W}$
V_{iso}	Isolation voltage	50Hz,R.M.S,t=1min, $I_{iso}:1\text{mA(max)}$		3000			V
F_m	Terminal connection torque(M8)				12.0		N·m
	Mounting torque(M6)				6.0		N·m
T_{vj}	Junction temperature			-40		150	$^\circ\text{C}$
T_{stg}	Stored temperature			-40		125	$^\circ\text{C}$
W_t	Weight				810		g
Outline		M03					

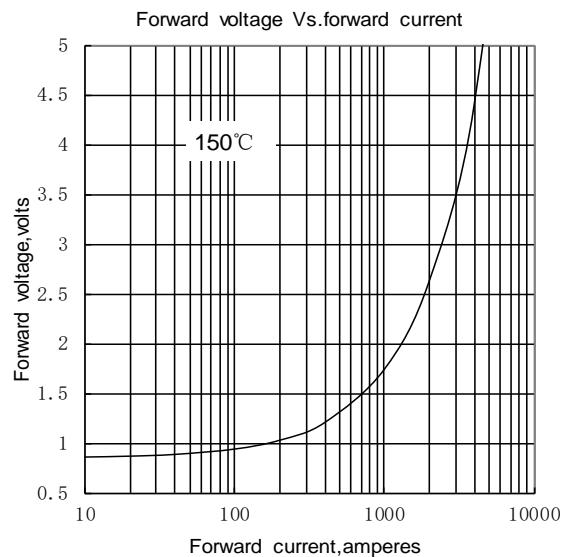


Fig.1

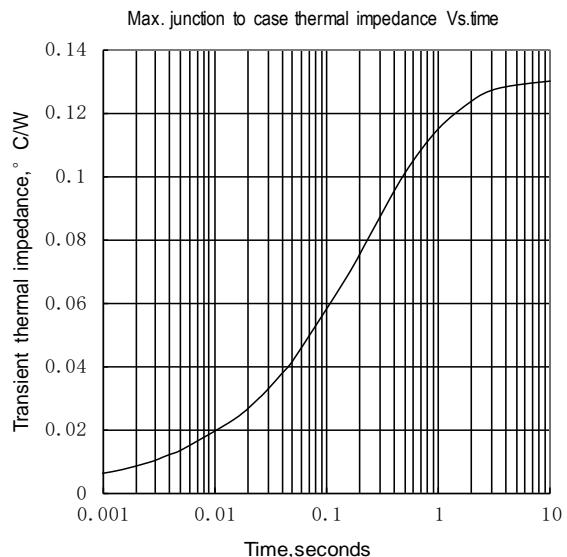


Fig.2

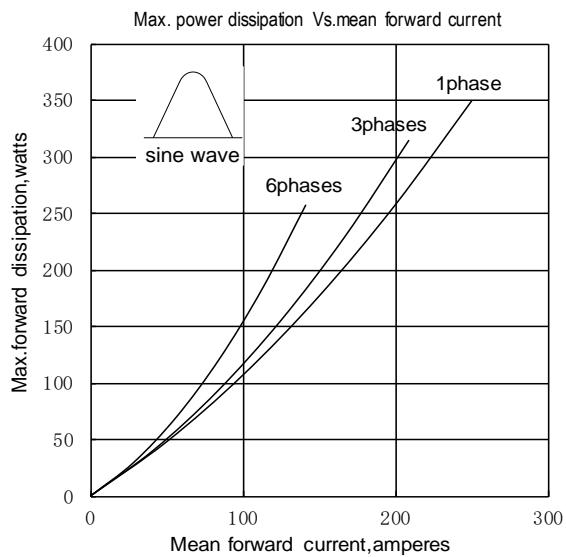


Fig.3

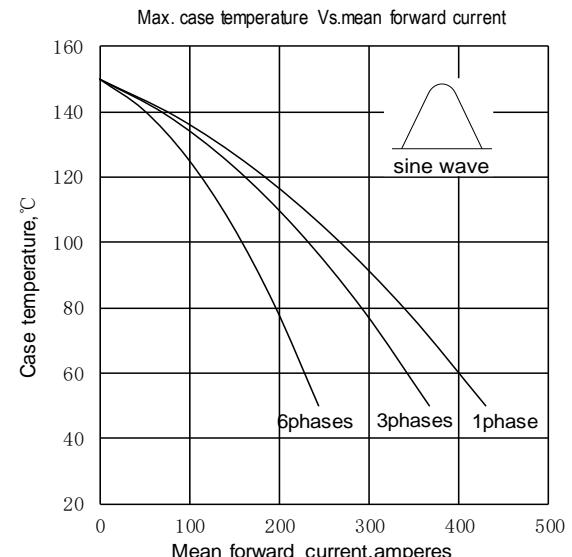


Fig.4

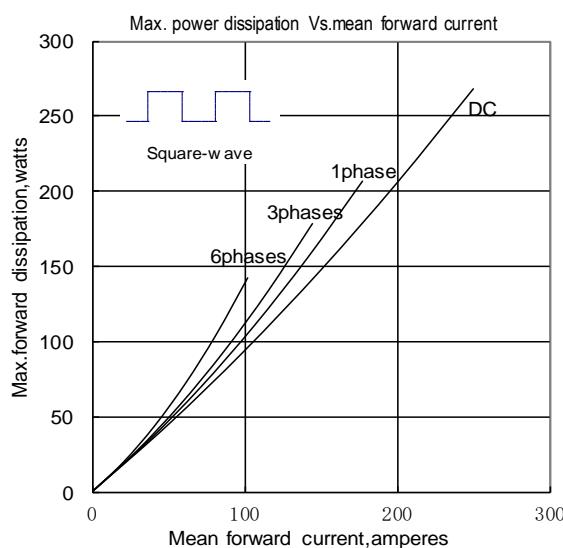


Fig.5

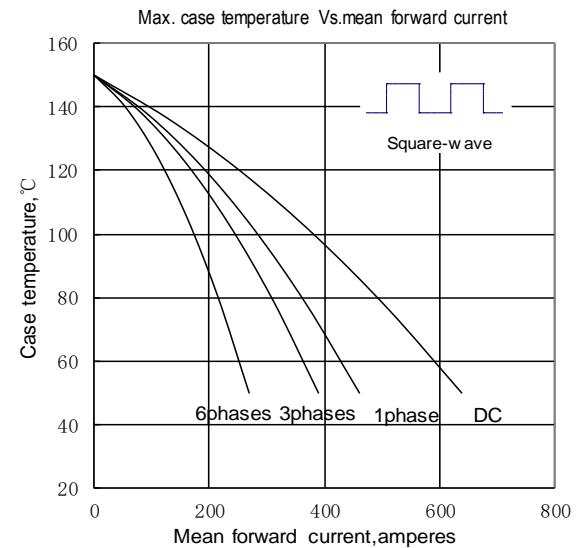


Fig.6

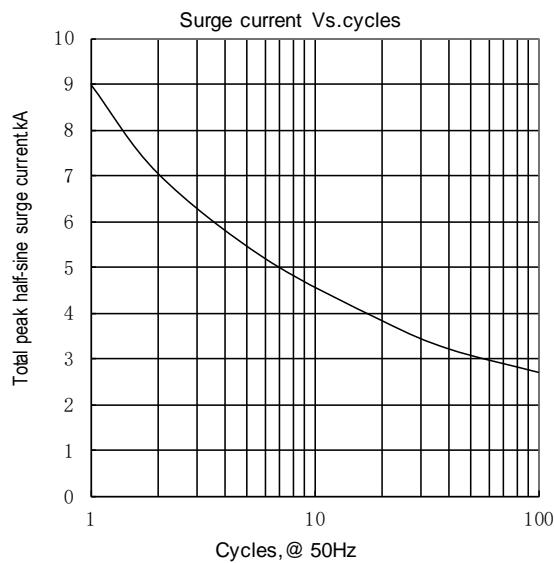
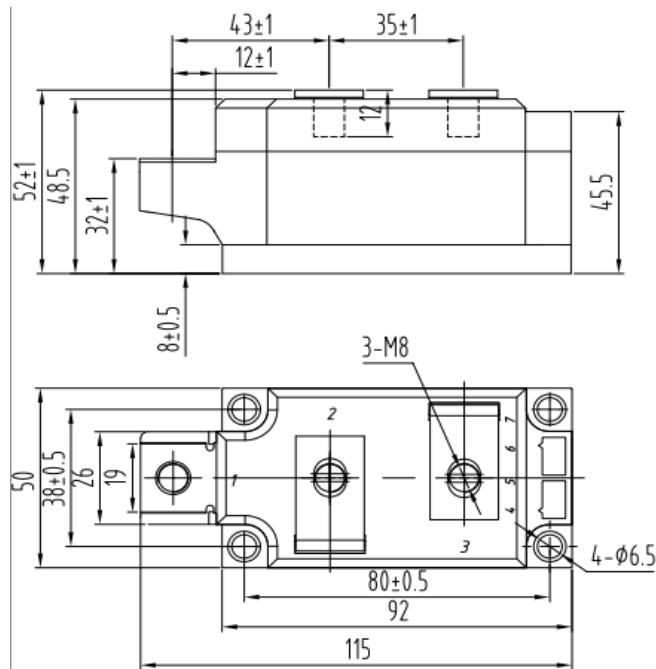


Fig.7

Unmarked dimensional tolerance : ± 0.5 mm